

# **Qualification Information**<sup>†</sup>

Qualification Level			Automotive (per AEC-Q100 <sup>††</sup> )		
		Comments: This family of ICs has pas	Comments: This family of ICs has passed an Automotive qualification. IR's Industrial and Consumer qualification level is granted by extension of the higher		
Moisture Sensitivity Level		D2PAK-5L	MSL1, 260°C (per IPC/JEDEC J-STD-020)		
		TO-220	Not applicable (non-surface mount package style)		
		DPAK-5L	MSL1, 260°C (per IPC/JEDEC J-STD-020)		
	Machine Model		Class M2 (+/-150V) <sup>111</sup> (per AEC-Q100-003)		
ESD	Human Body Model		Class H1C (+/-1500V) <sup>111</sup> (per AEC-Q100-002)		
E9D	Charged Device Model (DPAK,D2PAK)		Class C4 (+/-900V) <sup>ffr</sup> (per AEC-Q100-011)		
Charged Device Model (TO220)		Class C3B (+/-750V) <sup>ftr</sup> (per AEC-Q100-011)			
IC Latch	-Up Test	Class II, Level A (per AEC-Q100-004)			
RoHS Co	ompliant	Ye	Yes		

† Qualification standards can be found at International Rectifier's web site http://www.irf.com/

the Exceptions to AEC-Q100 requirements are noted in the qualification report.

††† Passing voltage level

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#### **Absolute Maximum Ratings**

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are referenced to Ground lead. Tj= -40°C..150°C, Vcc=6..35V (unless otherwise specified).

Symbol	Parameter	Min.	Max.	Units
Vout	Maximum output voltage	Vcc-35	Vcc+0.3	
Voffset	Maximum logic ground to load ground offset	Vcc-35	Vcc+0.3	
Vin	Maximum input voltage	-0.3	5.5	V
Vcc max.	Maximum Vcc voltage	_	36	v
Vcc cont.	Maximum continuous Vcc voltage	_	28	
Vcc sc.	Maximum Vcc voltage with short circuit protection	_	28	
lin max.	Maximum IN current		10	mA
ldg max.	Maximum diagnostic output current	-3	10	ШA
Vdg	Maximum diagnostic output voltage	-0.3	5.5	V
	Maximum power dissipation (internally limited by thermal protection)			
Pd	Rth=5°C/W AUIPS6021	_	25	W
Fu	Rth=40°C/W AUIPS6021S 1"sqrt. footprint	_	3.1	vv
	Rth=50°C/W AUIPS6021R 1"sqrt. footprint	_	2.5	
Tj max.	Max. storage & operating temperature junction temperature	-40	150	°C
Tsoldering	Soldering temperature (10 seconds)	_	300	°C

# **Thermal Characteristics**

Symbol	Parameter	Тур.	Max.	Units
Rth1	Thermal resistance junction to ambient AUIPS6021 TO220 free air	50	_	
Rth2	Thermal resistance junction to case AUIPS6021 TO220	2.6	_	
Rth1	Thermal resistance junction to ambient AUIPS6021S D <sup>2</sup> Pak std. footprint	60	_	
Rth2	Thermal resistance junction to ambient AUIPS6021S D <sup>2</sup> Pak 1" sqrt. Footprint	40	_	°C/W
Rth3	Thermal resistance junction to case AUIPS6021S D <sup>2</sup> Pak	2.6	_	C/vv
Rth1	Thermal resistance junction to ambient AUIPS6021R D-Pak std. footprint	70	_	
Rth2	Thermal resistance junction to ambient AUIPS6021R D-Pak 1" sqrt. Footprint	50	_	
Rth3	Thermal resistance junction to case AUIPS6021R D-Pak	2.6	_	

### **Recommended Operating Conditions**

These values are given for a quick design. For operation outside these conditions, please consult the application notes.

Symbol	Parameter	Min.	Max.	Units
VIH	High level input voltage	4	5.5	
VIL	Low level input voltage	0	0.9	
lout	Continuous drain current, Tambient=85°C, Tj=125°C, Vin=5V			
	Rth=5°C/W AUIPS6021	—	12	A
	Rth=40°C/W AUIPS6021S 1" sqrt. footprint	_	4.3	
	Rth=50°C/W AUIPS6021R 1" sqrt. footprint	_	3.9	
Rin	Recommended resistor in series with IN pin	4	10	
Rdgs	Recommended resistor in series with DG pin for reverse battery protection	4	20	kΩ
Rdgp	Recommended pull-up resistor for DG	4	20	K22
Rol	Recommended pull-up resistor for open load detection	5 100		
F max.	Max. switching frequency	_	1.5	kHz



#### **Static Electrical Characteristics**

Tj=-40°C..150°C, Vcc=6..28V (unless otherwise specified), typical values are given for Vcc=14V and Tj=25°C

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Rds(on)	ON state resistance Tj=25°C	_	24	30		Vin=5V, lout=10A
	ON state resistance Tj=150°C	_	42	52		Vin=5V, lout=10A
	ON state resistance Tj=25°C, Vcc=6V	_	29	36	mΩ	Vin=5V, lout=5A
	ON state resistance during reverse battery Tj=25°C	_	31	39		Vcc-Gnd=-14V
Vcc op.	Operating voltage range with short circuit protection	6	_	28	v	
V clamp 1	Vcc to Out clamp voltage 1	37	39	43	v	lout=40mA
V clamp 2	Vcc to Out clamp voltage 2	—	40	—		lout=8A (see Fig. 1)
Icc Off	Supply current when Off and Vout connected to ground with $R<4\Omega$	—	4	9	μA	Vin=0V, Vout=0V, Tj=25°C, Vcc=14V
Icc On	Supply current when On	_	2.2	5	mA	Vin=5V, Vcc=14V
Vih	Input high threshold voltage	_	2.5	3		
Vil	Input low threshold voltage	1.5	2	—	V	
In hyst.	Input hysteresis	0.2	0.5	1		
lin On	Input current when device is On	_	40	100		Vin=5V
ldg	Dg leakage current	_	0.1	10	μA	Vdg=5V
Vdg	Low level DG voltage	_	0.25	0.4	V	ldg=1.6mA

#### **Switching Electrical Characteristics**

Vcc=14V, Resistive load=6Ω, Vin=5V, Tj=-40°C..150°C, typical values are given for Tj=25°C

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Tdon	Turn-on delay time	_	14	40		
Tr1	Rise time to Vout=Vcc-5V	_	10	35	μs	
Tr2	Rise time to Vout=0.9 x Vcc	_	18	65		
dV/dt (On)	Turn On dV/dt	_	0.8	_	V/µs	
EOn	Turn On energy		250		μJ	see Fig. 3
Tdoff	Turn-off delay time		40	80		
Tf	Fall time to Vout=0.1 x Vcc	_	15	35	μs	
dV/dt (Off)	Turn Off dV/dt		1.5		V/µs	
EOff	Turn Off energy		100		μJ	



#### **Protection Characteristics**

Tj=-40°C..150°C, Vcc=6..28V (unless otherwise specified), typical values are given for Vcc=14V and Tj=25°C

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
llim	Internal current limit	19	32	50	Α	Vout=0V, Tj=25°C
Tsd+	Over temperature high threshold	150(1)	165	_	°C	See fig. 2
Tsd-	Over temperature low threshold	—	158		C	See lig. 2
Vsc	Short-circuit detection voltage(2)	2	3	4		
UV+	Under voltage protection Vcc going up	—	5	6.2		
UV-	Under voltage protection Vcc going down	—	4.5	5.8	V	
VOL Off	Open load detection threshold	2	3	4		
	Open load detection threshold	0.3	0.8	1.25	^	Tj=-4025°C
I OL On		0.3	0.7	1.1	A	Tj=25150°C

(1) Guaranteed by design

(2) Reference to Vcc

#### **True Table**

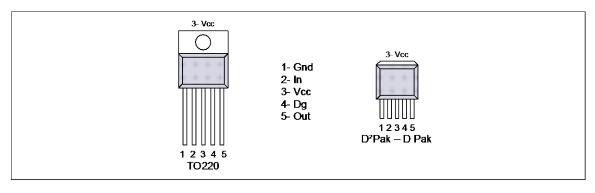
<b>Operating Conditions</b>	IN	OUT	DG
Normal	Н	Н	Н
Normal	L	L	Н
Open Load	Н	Н	L
Open Load (3)	L	Н	L
Short circuit to Gnd	Н	L	L
Short circuit to Gnd	L	L	Н
Short circuit to Vcc	Н	Н	L (4)
Short circuit to Vcc (5)	L	Н	L
Over-temperature	Н	L	L
Over-temperature	L	L	Н

(3) With a pull-up resistor connected between the output and Vcc.

(4) Vds lower than 10mV.

(5) Without a pull-up resistor connected between the output and Vcc.

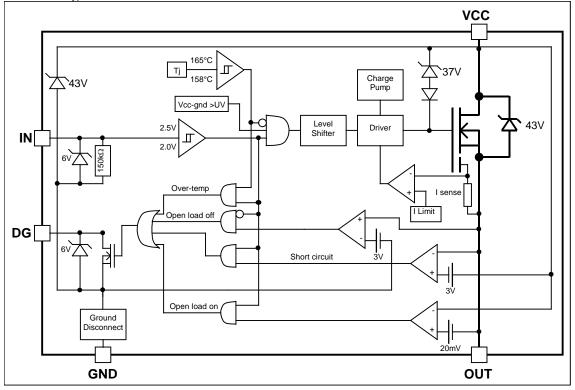
# Lead Assignments





# **Functional Block Diagram**

All values are typical



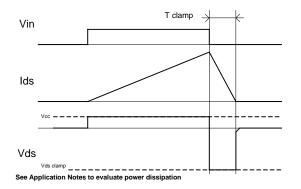


Figure 1 – Active clamp waveforms

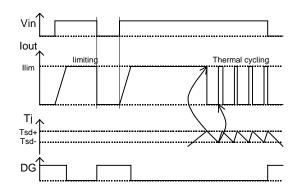
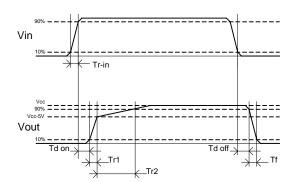
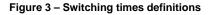
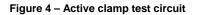


Figure 2 – Protection timing diagram





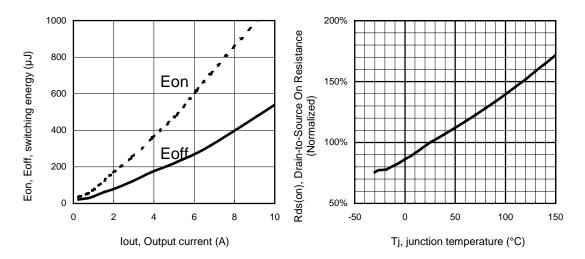
Dg Vcc Vclamp Gnd Out In ₹ L ′14\ 5V Vout Vin Л R Rem : 'nν During active clamp, Vload lout is negative

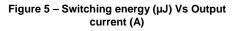


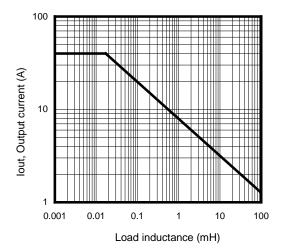
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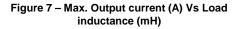
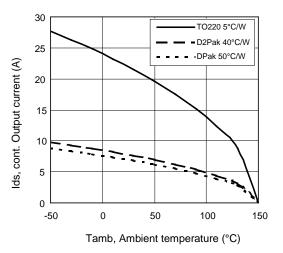
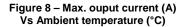


Figure 6 - Normalized Rds(on) (%) Vs Tj (°C)







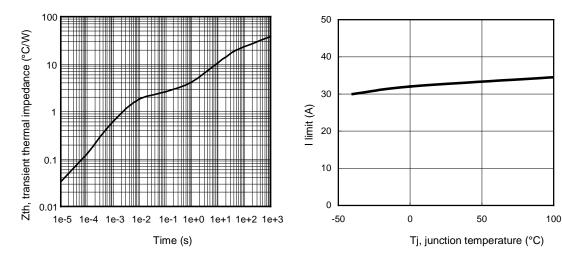
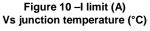
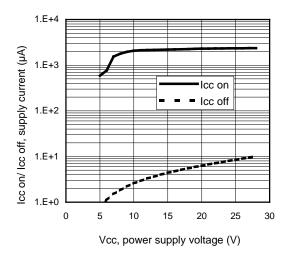


Figure 9 – Transient thermal impedance (°C/W) Vs time (s)







\*Vout connected to ground with R<4 $\Omega$ 

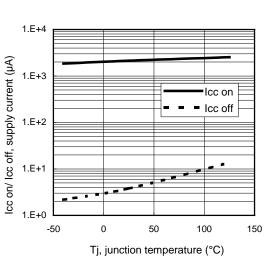
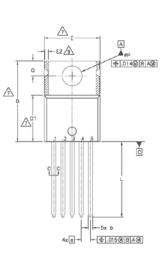


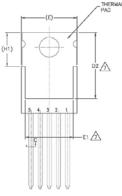
Figure 12 – Icc on/ Icc off (µA) Vs Tj (°C)\*

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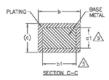


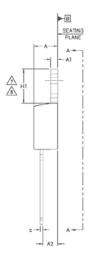
# Case Outline - TO220 (5 leads)











SY-MBO-	DIMENSIONS					
B	MILLIN	ETERS	INC	NOTES		
Ľ	MIN.	NAX.	MIN.	MAX.	s	
A	3.58	4.83	.140	.190		
A1	0.51	1.40	.020	.055		
A2	2.03	2.92	.080	.115		
ь	0.64	0.89	.025	.035		
b1	0.64	0.84	.025	.033	5	
c	0.35	0.61	.014	.024		
c1	0.36	0.56	.014	.022	5	
D	14.22	16.51	.560	.650	4	
D1	8.38	9.02	.330	.355		
D2	11.68	12.88	.460	.507	7	
E	9.65	10.67	.380	.420	4,7	
E1	6.86	8.89	.270	.350	7	
E2	-	0.76	-	.030	8	
0	1.70	BSC	.067	BSC		
H1	5.84	6.86	.230	.270	7,8	
L	12.70	14.73	.500	.580		
¢₽	3.53	3.73	.139	.147		
Q	2.54	3.05	.100	.120		

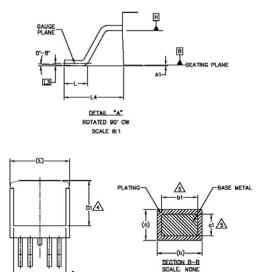
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- 3-
- 4.-

- <u>/5.</u>]
- 7.-
- 8.-
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- 10.- LEADS AND DRAIN ARE PLATED WITH 100% Sn

# **Case Outline D2PAK - 5 Leads**



- NOTES:
- 1. DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M-1994
- 2. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
- DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.127 (.005") PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY AT DATUM H.
- THERMAL PAD CONTOUR OPTIONAL WITHIN DIMENSION E, L1, D1 & E1.
- S DIMENSION 61 AND c1 APPLY TO BASE METAL ONLY.
- 6. DATUM A & B TO BE DETERMINED AT DATUM PLANE H.
- 7. CONTROLLING DIMENSION: INCH.
- 8. OUTLINE CONFORMS TO JEDEC OUTLINE TO-263BA.
- 9 LEADS AND DRAIN ARE PLATED : 100% Sn

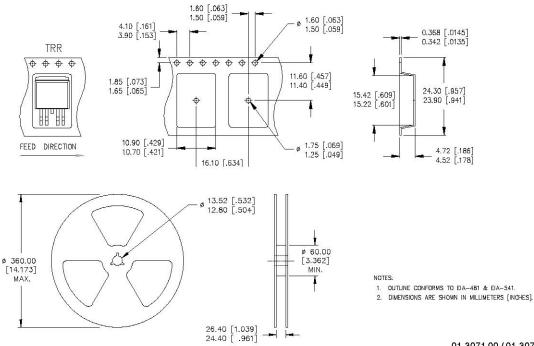
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Y M			N		
B	мши	ETERS	INC	HES	0 T
BOL	MIN.	MAX.	MIN.	MAX.	Ē
A	4.06	4.83	.160	.190	
A1	-	0.254	-	.010	
b	0.51	0.99	.020	.039	4
b1	D.51	0.89	.020	.035	
c	0.38	0.74	.015	.029	
e1	0.38	0.58	.015	.023	4
c2	1.14	1.65	.045	.065	
D	8.38	9.65	.330	.380	3
D1	6.86	-	.270	-	
E	9.65	10.67	.380	.420	3
E1	6.22	-	.245	-	
e	1.70	BSC	.067	BSC	
н	14.61	15.88	.575	.625	
L	1.78	2.79	.070	.110	
U1	-	1.68	-	.066	
L2	-	1.78	-	.070	
L3	0.25	BSC	.010	BSC	
L4	4.78	5.28	.188	.208	

VEW A-A



# Tape & Reel D2PAK - 5 Leads



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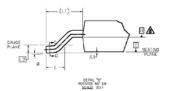
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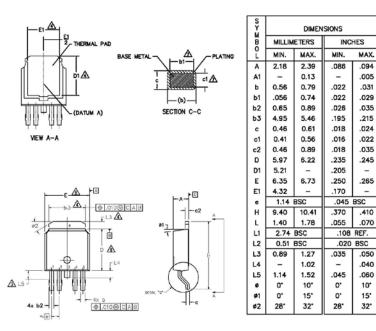
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### **Case Outline DPAK - 5 Leads**



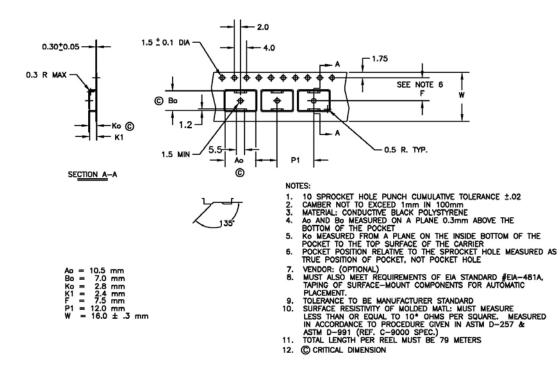


NOTES:

- 1.- DIMENSIONING AND TOLERANCING AS PER ASME Y14.5M-1994
- 2.- DIMENSION ARE SHOWN IN INCHES [MILLIMETERS].
- A- LEAD DIMENSION UNCONTROLLED IN L5.
- A- DIMENSION D1, E1, L3 & b3 ESTABLISH A MINIMUM MOUNTING SURFACE FOR THERMAL PAD.
- 5.- SECTION C-C DIMENSIONS APPLY TO THE FLAT SECTION OF THE LEAD BETWEEN .005 AND 0.10 [0.13 AND 0.25] FROM THE LEAD TIP.
- A DIMENSION D & E DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED .005 [0.13] PER SIDE. THESE DIMENSIONS ARE MEASURED AT THE OUTMOST EXTREMES OF THE PLASTIC BODY.
- A- DIMENSION 51 & c1 APPLIED TO BASE METAL ONLY.
- 8.- DATUM A & B TO BE DETERMINED AT DATUM PLANE H.
- 9.- OUTLINE CONFORMS TO JEDEC OUTLINE TO-252.
- 10. LEADS AND DRAIN ARE PLATED WITH 100% Sn

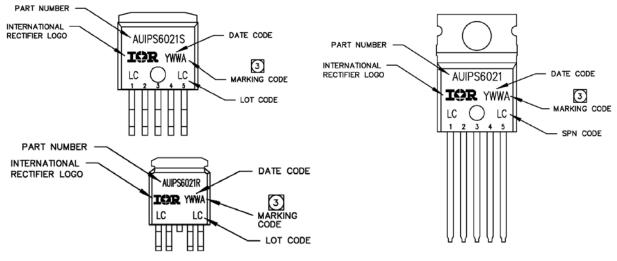


#### Tape & Reel DPAK - 5 Leads





# **Part Marking Information**



### **Ordering Information**

Base Part Number	De alta en Trata	Standard Pack		
Dase I alt Number	Package Type	Form	Quantity	Complete Part Number
AUIPS6021	TO220-5-Leads	Tube	50	AUIPS6021
		Tube	50	AUIPS6021S
AUIPS6021S	D2-Pak-5-Leads	Tape and reel left	800	AUIPS6021STRL
		Tape and reel right	800	AUIPS6011STRR
	D-Pak-5-Leads	Tube	75	AUIPS6021R
AUIPS6021R		Tape and reel	2000	AUIPS6021RTR
AUIPS6021R		Tape and reel left	3000	AUIPS6021RTRL
		Tape and reel right	3000	AUIPS6021RTRR

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# **Revision History**

Revision	Date	Notes/Changes
В	September, 12th 2011	AU release
С	May 15, 2012	Add the test condition for the ICC (off)
		parameters
D	Tuesday, October 16, 2012	Update the date in the front page